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With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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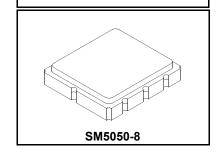






**SF2120C** 

# 149.00 MHz **SAW Filter**



- · Designed for Broadband Receiver IF Applications
- Low Insertion Loss
- 5.0 X 5.0 mm Surface-mount Case
- · Differential Input and Single-ended Output
- Complies with Directive 2002/95/EC (RoHS)

#### **Absolute Maximum Ratings**

Rating	Value	Units
Maximum Incident Power in Passband	+10	dBm
Maximum DC Voltage on any Non-ground Terminal	3	VDC
Storage Temperature Range in Tape and Reel	-40 to +85	°C
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s	

#### **Electrical Characteristics**

Characteristic	Sym	Min	Тур	Max	Units
Nominal Center Frequency	f <sub>C</sub>		149.00		MHz
Insertion Loss			2.0	2.5	dB
2 dB Passband		148 to 150	147.65 to 150.35		MHz
Amplitude Ripple, 148 to 150 MHz, -27.5 to 72.5 °C			1.5	1.8	dB <sub>P-P</sub>
Amplitude Ripple, 148 to 150 MHz, -40 to -27.5 °C, 72.5 to 85 °C			2.0	2.2	dB <sub>P-P</sub>
Rejection, f <sub>C</sub> -2.5 MHz		15	54		dB
Rejection, f <sub>C</sub> +2.5 MHz		15	30		dB
Center Frequency Temperature Coefficent			-30		ppm/K
Operating Temperature		-40		85	°C
Case Style		SM5050-8 5 x 5 mm Nominal Footprint			
Lid Symbolization (Y=year, WW=week, S=shift)		RFM 635 <u>YWWS</u>			

#### **Electrical Connections - Differential Operation**

Connection		Terminals	
Port 1	Differential Input	1, 2	
Port 2	Output	5	
	Ground	All others	
Dot indicates Pin 1			

#### **Electrical Connections - Single End Operation**

Connection		Terminals
Port 1	Input	1
Port 2	Output	5
	Ground	All others
Dot indicates Pin 1		

### CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

### NOTES:

- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network analyzer.
- Rejection is measured as attenuation below the minimum IL point in the passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42 for details.

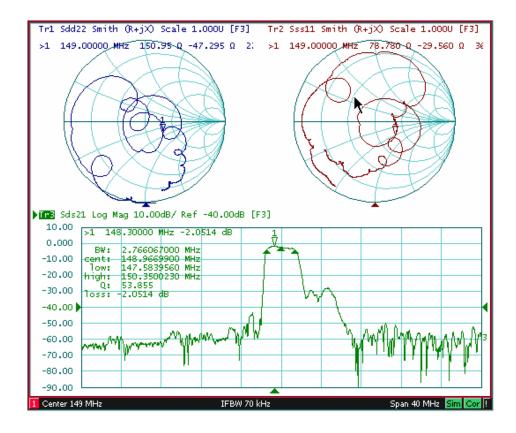
- The design, manufacturing process, and specifications of this filter are subject to change.

  Tape and Reel Standard ANSI / EIA 481.

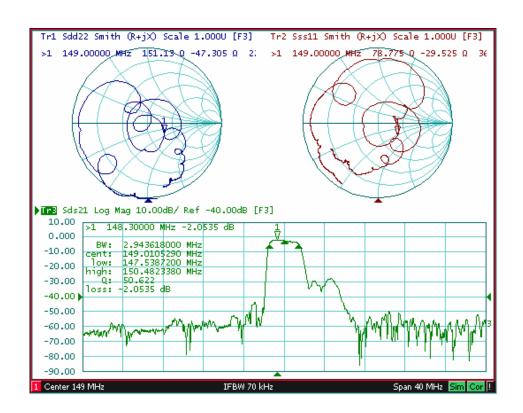
  US and international patents may apply.

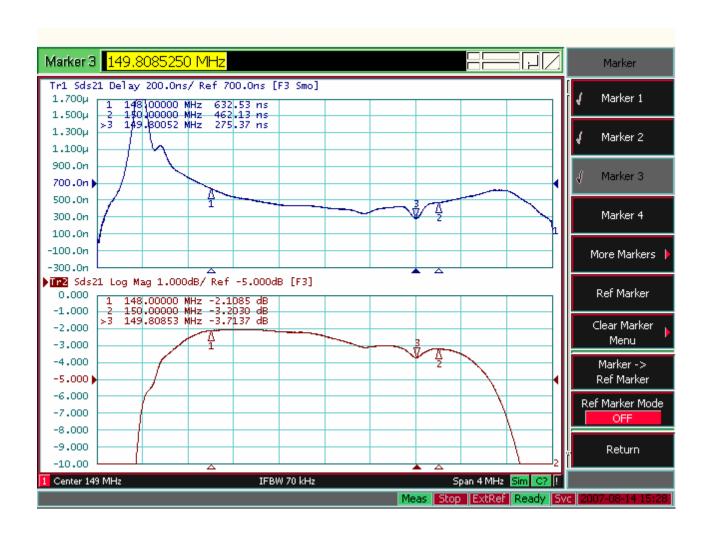
  Murata, stylized Murata logo, and Murata N.A., Inc. are registered trademarks of Murata Manufacturing Co., Ltd.
- The center frequency will move with ambient temperature changes.

#### 2 dB BW

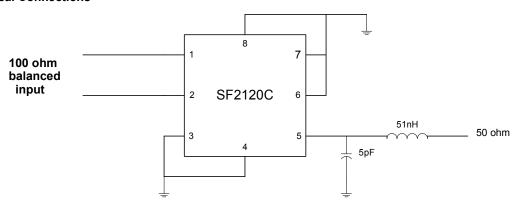


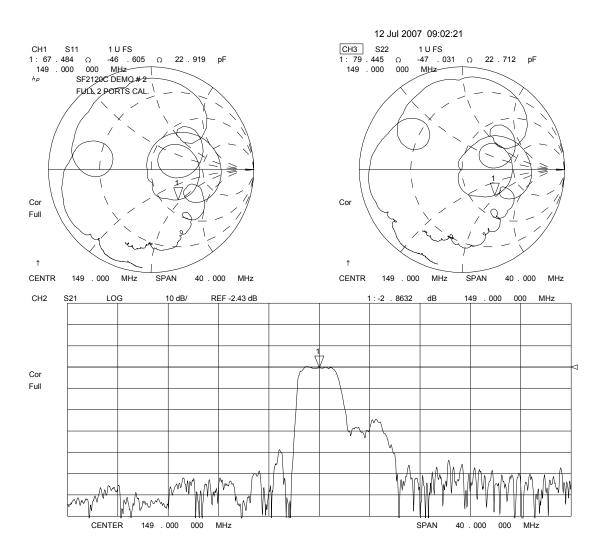
#### 3 dB BW

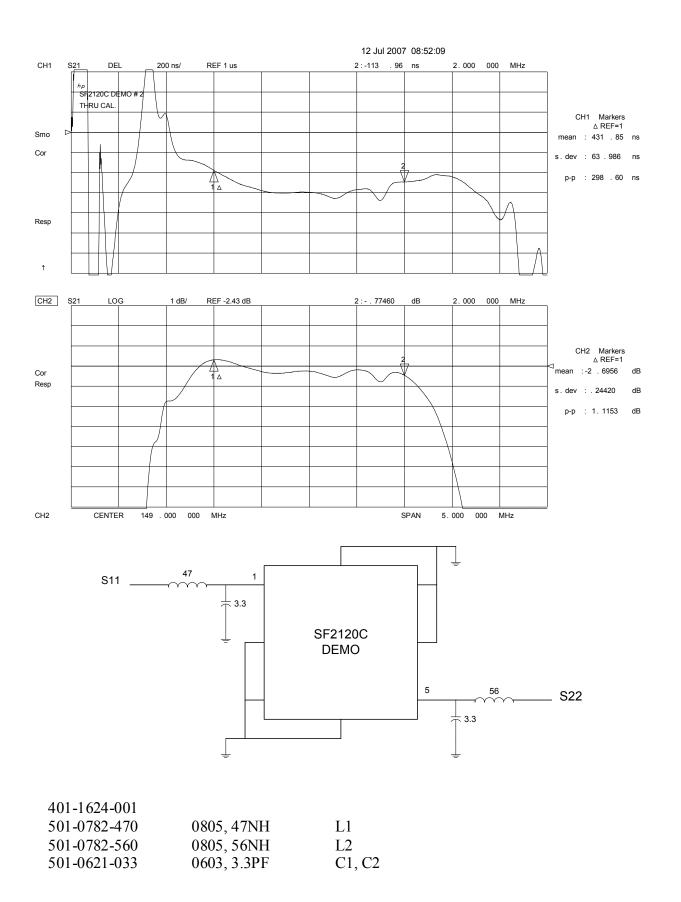




#### **Electrical Connections**

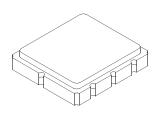


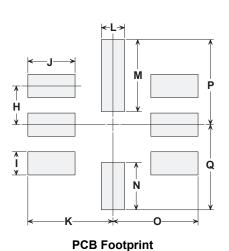




# SM5050-8 Surface-Mount 8-Terminal Ceramic Case 5.0 X 5.0 mm Nominal Footprint



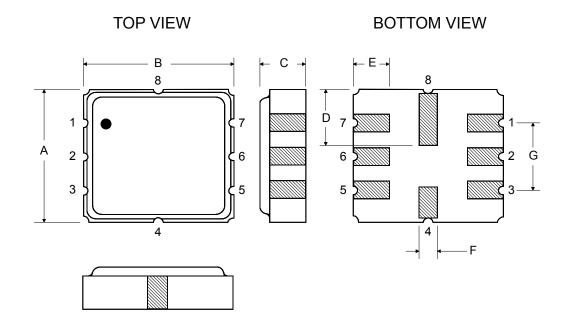




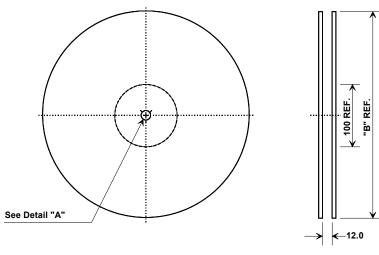
Dimension	mm		Inches			
Difficusion	Min	Nom	Max	Min	Nom	Max
Α	4.80	5.00	5.20	0.189	0.197	0.205
В	4.80	5.00	5.20	0.189	0.197	0.205
С	1.30	1.50	1.70	0.050	0.060	0.067
D	1.98	2.08	2.18	0.078	0.082	0.086
E	1.07	1.17	1.27	0.042	0.046	0.050
F	0.50	0.64	0.70	0.020	0.025	0.028
G	2.39	2.54	2.69	0.094	0.100	0.106
Н		1.27			0.050	
I		0.76			0.030	
J		1.55			0.061	
K		2.79			0.110	
L		0.76			0.030	
М		2.36			0.093	
N		1.55			0.061	
0		2.79			0.110	
P		2.79			0.110	
Q		2.79			0.110	

#### **Case Materials**

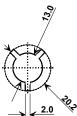
Materials			
Solder Pad Plating	0.3 to 1.0 µm Gold over 1.27 to 8.89 µm Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
Pb Free			



## **Tape and Reel Specifications**



"B" Nominal Size		Quantity Per Reel	
Inches	millimeters		
7	178	500	
13	330	3000	



#### **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions	
Ao	5.3 mm
Во	5.3 mm
Ko	2.0 mm
Pitch	8.0 mm
W	12.0 mm

